

100 32 543.2
7.58124

[10191/2251]

**COMBINED DECLARATION AND
POWER OF ATTORNEY FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

I My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **ARRANGEMENT HAVING P-DOPED AND N-DOPED SEMICONDUCTOR LAYERS, AND METHOD FOR THE MANUFACTURE THEREOF** the specification of which was filed as PCT International Application No. **PCT/DE01/02309** on **June 22, 2001**.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

Number	Country Filed	Day/Month/Year	Priority Claimed Under 35 U.S.C. 119
100 32 543.2	Federal Republic of Germany	05 July 2000	Yes

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The diagram shows a schematic of the experimental setup. A laser beam is directed through a series of optical components including a beam splitter, a lens, and a sample. The resulting signal is captured by a detector and processed by a computer. The setup is designed to study the interaction of light with a sample under various conditions.

KENYON & KENYON
One Broadway
New York, New York 10004



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PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful and false statements may jeopardize the validity of the application or any patent issued thereon.

XXXXXXXXXXXXXXXXXXXX

Full name of inventor

FD

Richard SPITZ

Inventor's signature

Richard Spitz

Date 05/13/02

Citizenship

Federal Republic of Germany

Residence

Roemersteinstr. 56

72766 Reutlingen

Federal Republic of Germany

DEX

Post Office Address

Same as above

Full name of inventor

Alfred GOERLACH

Inventor's signature

Alfred Gölzer

Date _____

2002/05/06

Citizenship

Federal Republic of Germany

Residence

Bismarckstr. 70

72127 Kusterdingen

Federal Republic of Germany

Post Office Address_

Same as above